

MICROCIRCUIT DATA SHEET

Original Creation Date: 03/21/97 Last Update Date: 05/04/01

Last Major Revision Date: 04/20/01

LOW DROPOUT ADJUSTABLE REGULATOR

General Description

MNLM2941-X REV 4A1

The LM2941 positive voltage regulator features the ability to source 1A of output current with a typical dropout voltage of 0.5V and a maximum of 1V over the entire temperature range. Furthermore, a quiescent current reduction circuit has been included which reduces the ground pin current when the differential between the input voltage and the output voltage exceeds approximately 3V. The quiescent current with 1A of output current and an input-output differential of 5V is therefore only 30mA. Higher quiescent currents only exist when the regulator is in the dropout mode (Vin - Vout \leq 3V).

Designed also for vehicular applications, the LM2941 and all regulated circuitry are protected from reverse battery installations or two-battery jumps. During line transients, such as load dump when the input voltage can momentarily exceed the specified maximum operating voltage, the regulator will automatically shut down to protect both the internal circuits and the load. Familiar regulator features such as short circuit and thermal overload protection are also provided.

Industry Part Number

NS Part Numbers

LM2941

Prime Die

LM2941

LM2941J-MLS LM2941J-QMLV LM2941J/883 LM2941WG-QMLV LM2941WG/883

Controlling Document

SEE FEATURES SECTION

Processing Subgrp Description Temp (°C) MIL-STD-883, Method 5004 1 Static tests at +25

Quality Conformance Inspection

MIL-STD-883, Method 5005

2	Static tests at	+125
3	Static tests at	-55
4	Dynamic tests at	+25
5	Dynamic tests at	+125
6	Dynamic tests at	-55
7	Functional tests at	+25
8A	Functional tests at	+125
8B	Functional tests at	-55
9	Switching tests at	+25
10	Switching tests at	+125
11	Switching tests at	-55

Features

- Output voltage adjustable from 5V to 20V
- Dropout voltage typically 0.5V @ Io = 1A
- Output current in excess of 1A
- Trimmed reference voltage
- Reverse battery protection
- Internal short circuit current limit
- Mirror image insertion protection
- TTL, CMOS compatible ON/OFF switch
- CONTROLLING DOCUMENT

LM2941J-QMLV 5962-9166701VEA LM2941J/883 5962-9166701QEA LM2941WG-QMLV 5962-9166701VYA LM2941WG/883 5962-9166701QYA

(Absolute Maximum Ratings)

(Note 1)

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Input Voltage (Survival Voltage ≤ 100mS)
                                                           607
Internal Power Dissipation
(Note 2, 3)
                                                          Internally Limited
Maximum Junction Temperature
                                                          150 C
Storage Temperature Range
                                                           -65 C \leq TA \leq +150 C
Lead Temperature
    (Soldering, 10 seconds)
                                                           300 C
Thermal Resistance
    ThetaJA
                                                            73 C/W
      CERDIP
                     (Still Air)
                     (500LF/Min Air Flow)
      CERDIP
                                                            37 C/W
      CERAMIC SOIC
                     (Still Air)
                                                           122 C/W
      CERAMIC SOIC (500LF/Min Air Flow)
                                                            77 C/W
    ThetaJC
      CERDIP
                                                            3 C/W
      CERAMIC SOIC
                                                            5 C/W
Package Weight
    (Typcial)
    CERDIP
                                                           1970mg
    CERAMIC SOIC
                                                            360ma
ESD Susceptibility
(Note 4)
                                                           500V
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- Note 1: Absolute Maximum Ratings indicate limits beyond which damage to the device may occur.

 Operating Ratings indicate conditions for which the device is functional, but do not guarantee specific performance limits. For guaranteed specifications and test conditions, see the Electrical Characteristics. The guaranteed specifications apply only for the test conditions listed. Some performance characteristics may degrade when the device is not operated under the listed test conditions.

 Note 2: The maximum power dissipation must be derated at elevated temperatures and is distanted by Times (maximum posterior). The table (preference in protein to the proposal protein to the protein to the protein terms of the protei
- Note 2: The maximum power dissipation must be derated at elevated temperatures and is dictated by Tjmax (maximum junction temperature), ThetaJA (package junction to ambient thermal resistance), and TA (ambient temperature). The maximum allowable power dissipation at any temperature is Pdmax = (Tjmax TA)/ThetaJA or the number given in the Absolute Maximum Ratings, whichever is lower.
- Note 3: The package material for these devices allows much improved heat transfer over our standard ceramic packages. In order to take full advantage of this improved heat transfer, heat sinking must be provided between the package base (directly beneath the die), and either metal traces on, or thermal vias through, the printed circuit board. Without this additional heat sinking, device power dissipation must be calculated using junction-to-ambient, rather than junction-to-case, thermal resistance. It must not be assumed that the device leads will provide substantial heat transfer out of the package, since the thermal resistance of the leadframe material is very poor, relative to the material of the package base. The stated junction-to-case thermal resistance is for the package material only, and does not account for the additional thermal resistance between the package base and the printed circuit board. The user must determine the value of the additional thermal resistance and must combine this with the stated value for the package, to calculate the total allowed power dissipation for the device.
- Note 4: Human body model, 100pF discharged through 1.5K Ohms.

Recommended Operating Conditions

(Note 1)

Input Voltage

26V

Operating Temperature Range

-55 C \leq TA \leq +125 C

Note 1: Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is functional, but do not guarantee specific performance limits. For guaranteed specifications and test conditions, see the Electrical Characteristics. The guaranteed specifications apply only for the test conditions listed. Some performance characteristics may degrade when the device is not operated under the listed test conditions.

Electrical Characteristics

DC PARAMETERS:

(The following conditions apply to all the following parameters, unless otherwise specified.) DC: $5V \le Vo \le = 20V$, Vin = Vo +5V, Cout = 22uF

SYMBOL	PARAMETER	CONDITIONS	NOTES	PIN- NAME	MIN	MAX	UNIT	SUB- GROUPS
Vref	Reference Voltage	5mA ≤ Io ≤ 1A			1.237	1.313	V	1
					1.211	1.339	V	2, 3
Vrline	Line Regulation	Vo + 2V ≤ Vin ≤ 26V, Io = 5mA	3			10	mV/V	1, 2,
Vrload	Load Regulation	50mA ≤ Io ≤ 1A	3			10	mV/V	1, 2,
Iq	Quiescent Current	$Vo + 2V \le Vin \le 26V$, $Io = 5mA$				15	mA	1
						20	mA	2, 3
		Vin = Vo + 5V, Io = 1A				45	mA	1
						60	mA	2, 3
Vdo	Dropout Voltage	Io = 1A				0.8	V	1
						1.00	V	2, 3
		Io = 100mA				200	mV	1
						300	mV	2, 3
Isc	Short Circuit Current	Vin max = 26V			1.6	3.5	A	1
					1.3	3.7	A	2, 3
	Maximum Operational Input Voltage		2			26	Vdc	1, 2,
	Reverse Polarity DC Input Voltage	Ro = 100 Ohms, Vo \geq -0.6V	1		-15		V	1, 2,
V(TO)	ON/OFF Threshold Voltage ON	Io ≤ 1A	1			0.8	V	1, 2,
V(TO)	ON/OFF Threshold Voltage OFF	Io ≤ 1A	1		2.00		V	1, 2,
	ON/OFF Threshold Current	V ON/OFF = $2.0V$, Io $\leq 1A$				100	uA	1
	Carrent					300	uA	2, 3

Electrical Characteristics

AC PARAMETERS:

(The following conditions apply to all the following parameters, unless otherwise specified.) AC: $5V \le Vo \le = 20V$, Vin = Vo +5V, Cout = 22uF

SYMBOL	PARAMETER	CONDITIONS		PIN- NAME	MIN	MAX	UNIT	SUB- GROUPS
	Maximum Line Transient	Vo max 1V above nominal Vo, Ro = 100 Ohms, T ≤ 100mS			60		V	4, 5, 6
	Reverse Polarity Transient Input Voltage	T < 100mS, Ro = 100 Ohms			-50		V	4, 5,
RR	Ripple Rejection	fo = 1KHz, 1 Vrms, IL = 100mA	4			0.02	%/V	4
			4			0.04	%/V	5, 6

DC PARAMETERS: DRIFT VALUES

(The following conditions apply to all the following parameters, unless otherwise specified.) AC: $5V \le Vo \le 20V$, Vin = Vo +5V, Cout = 22uF. "Delta Calculations performed on JAN S and QMLV devices at Group B, Subgroup 5 ONLY"

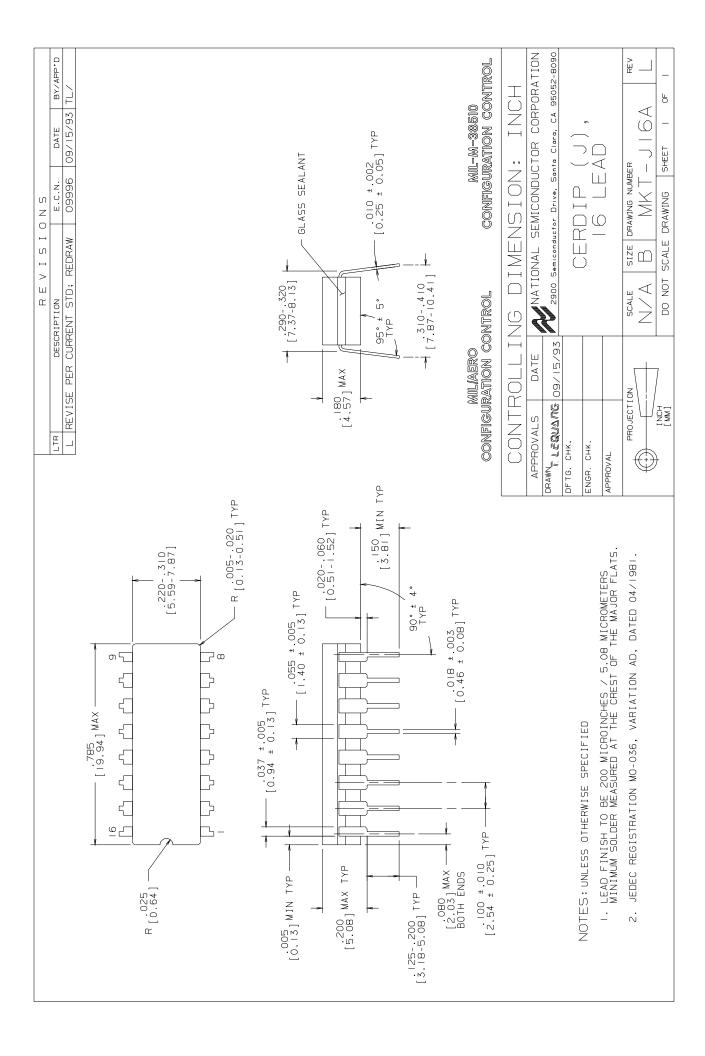
Vref	Reference Voltage	5mA ≤ Io ≤ 1A		-25	+25	mV	1

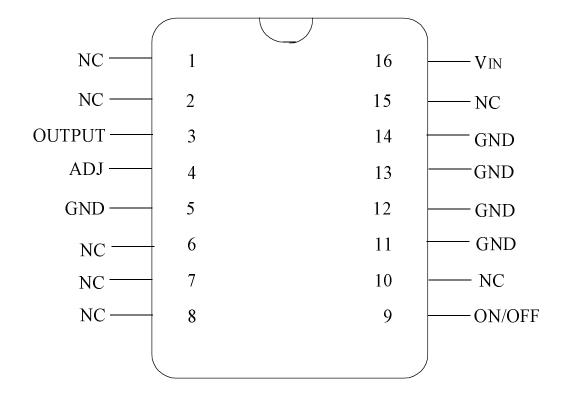
Note 1: Functional test go no go only.
Note 2: Condition for Vin.
Note 3: Limit = mV per Volt of Vout.
Note 4: %/V = % of Vin per Volt of Vout.

Graphics and Diagrams

GRAPHICS#	DESCRIPTION
06333HRA2	CERDIP (J), 16 LEAD (B/I CKT)
06352HRA1	CERPACK (W), 16 LEAD (B/I CKT)
J16ARL	CERDIP (J), 16 LEAD (P/P DWG)
P000158A	CERDIP (J), 16 LEAD (PINOUT)
P000378A	CERAMIC SOIC, 16 LEAD (PINOUT)
WG16ARC	CERAMIC SOIC (WG), 16 LEAD (P/P DWG)

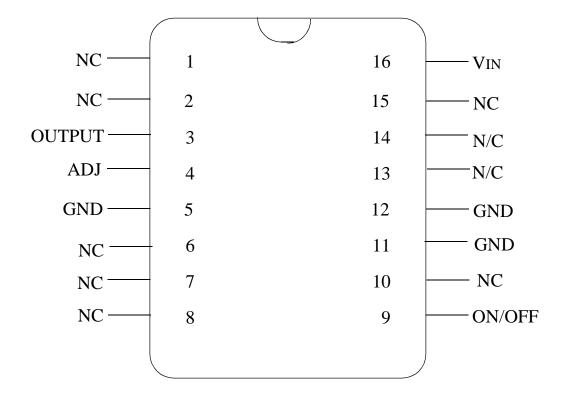
See attached graphics following this page.





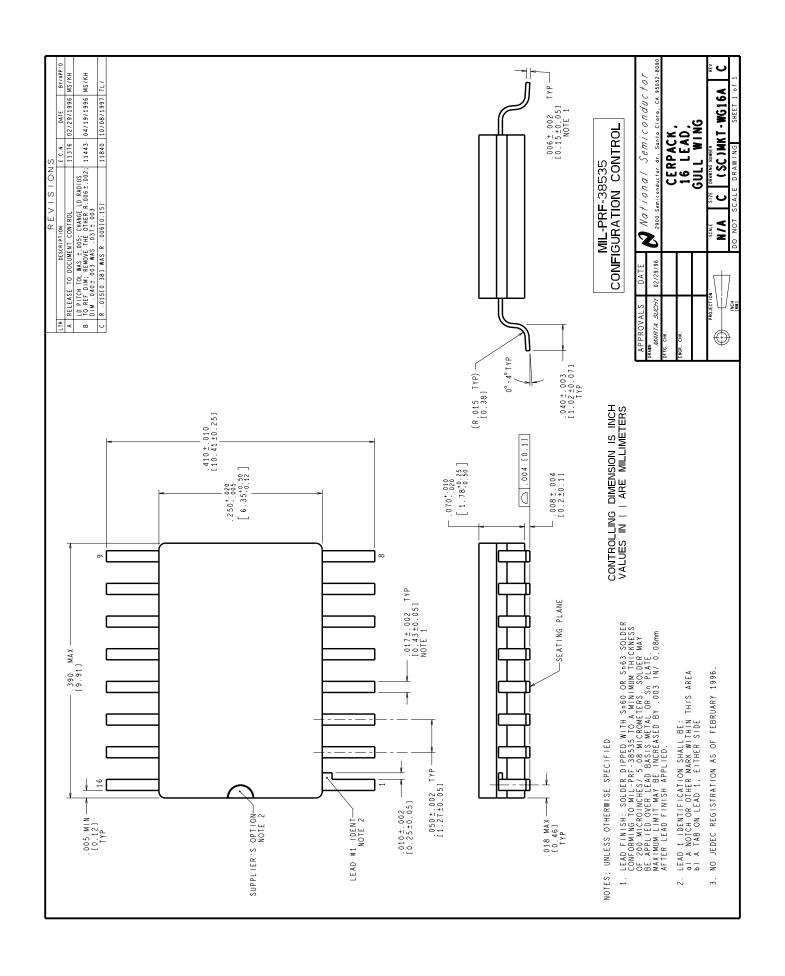
LM2941J/883 16 - LEAD DIP CONNECTION DIAGRAM TOP VIEW P000158A





LM2941WG 16 - LEAD CERAMIC SOIC CONNECTION DIAGRAM TOP VIEW P000378A





Revision History

Rev	ECN #	Rel Date	Originator	Changes
0A0	M0001075	02/11/99	Barbara Lopez	Initial Release of: MNLM2941-X Rev. 0A0. Added note for power dissipation and reference to thermal resistance for Aluminum Nitride package.
1A1	M0003224	10/08/99	Rose Malone	Update MDS: MNLM2941-X, Rev. 0A0 to MNLM2941-X, Rev. 1A1.
2A1	M0003559	11/28/00	Rose Malone	Update MDS: MNLM2941-X, Rev. 1A1 to MNLM2941-X, Rev. 2A1. Changed Vdo, Io = 100mA, Max. condition subgroup to Subgroup 1 at 200mV and Subgroup 2 and 3 at 300mV.
2B1	M0003777	01/31/01	Rose Malone	Update MDS: MNLM2941-X, Rev. 2A1 to MNLM2941-X, Rev. 2B1. Added MLS part number reference to Main Table.
3A1	M0003783	05/04/01	Rose Malone	Update MDS: MNLM2941-X, Rev. 2B1 to MNLM2941-X, Rev. 3A1. Changed Electrical Section DC parameter Isc Max limit Subgroup 1 from 3.3A to 3.5A and Subgroups 2, 3 from 3.5A to 3.7A
4A1	M0003801	05/04/01	Rose Malone	Update MDS: MNLM2941-X, Rev. 3Al to MNLM2941-X, Rev. 4Al. Removed on Main Table, Feature Section and Graphics Section reference to K pkg. Added Main Table Feature Section reference to WG pkg and Drift Value Parameter to Electrical Section.